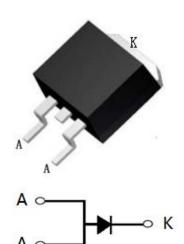


FRED Ultrafast Soft Recovery Diode, 15A

Features:

- Ultrafast Recovery
- 175°C operating junction temperature
- High frequency operation
- Low power loss, less RFI and EMI
- Low I_R value
- High surge capacity
- Epitaxial chip construction



Product Summary		
VR	600 V	
IF(AV)	15A	
trr	24 ns	

Description/Applications

These diodes are optimized to less losses and EMI/RFI in high frequency power conditioning system. The soft recovery behavior of the diodes offers the need as snubber in most applications. These devices are ideally suited for HF welding power converters and other applications where the switching losses are not significant portion of the total losses.

Absolute Maximum Ratings					
Parameter	Symbol	Test Conditions	Values	Units	
Repetitive peak reverse voltage	Vrrm		600	V	
Continuous forward current	lf(AV)	Tc =110°C	15		
Single pulse forward current	IFSM	Tc =25°C	150	Α	
Maximum repetitive forward current	IFRM	Square wave, 20kHZ	30		
Operating junction	Tj		175	°C	
Storage temperatures	Tstg		-55 to +175	°C	

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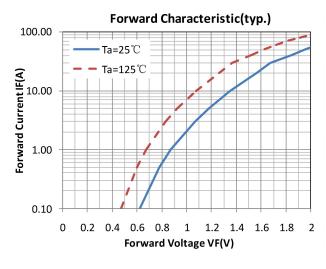


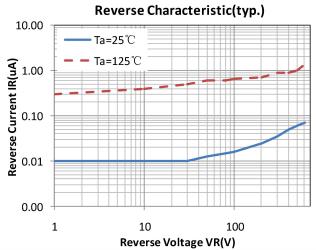
Parameter	Symbol	Test Conditions	Min	Тур.	Max.	Units
Breakdown voltage Blocking voltage	VBR, V _R	Ir=100µA	600			
Forward voltage (Per Diode)		IF=15A		1.35	1.7	V
	VF	I _F =15A, Tj =125°C		1.25	1.6	
Reverse leakage		Vr= Vrrm			20	_
current(Per Diode)	lR	Tj=150°C, Vr=600V			200	μΑ
Reverse recovery time(Per Diode)		I _F =0.5A, I _R =1A, I _{RR} =0.25A		35	50	
	trr	I _F =1A,V _R =30V, di/ <i>dt</i> =200A/us		24	35	ns

Thermal characteristics

Paramter	Symbol	Тур	Units
Junction-to-Case	$R_{ heta JC}$	2.5	°C/W

Electrical performance (typic)



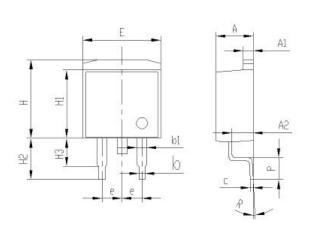


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Package Information

TO-263 PACKAGE



Symbol	Dimensions(millimeters)		
Symbol	Min.	Max.	
Α	4.50	4.90	
A1	1.17	1.37	
A2	2.40	2.80	
b	0.60	1.00	
b1	0.95	1.35	
С	0.26	0.50	
е	2.34	2.74	
Е	9.70	10.1	
Н	9.80	10.2	
H1	8.50	8.90	
H2	5.05	5.45	
H3	3.60	4.00	
R	0°	6°	
Р	2.55	2.95	

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